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(12) United States Design Patent

Yamaguchi et al.

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(54) **ROTARY TOOL FOR BOAT OF SEMICONDUCTOR MANUFACTURING APPARATUS**

(71) Applicant: **Hitachi Kokusai Electric Inc.**, Tokyo (JP)

(72) Inventors: **Takatomo Yamaguchi**, Toyama (JP); **Takashi Nogami**, Toyama (JP)

(73) Assignee: **HITACHI KOKUSAI ELECTRIC INC.**, Tokyo (JP)

(**) Term: **15 Years**

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(22) Filed: **Jul. 28, 2016**

(30) **Foreign Application Priority Data**

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(51) **LOC (11) Cl.** **15-09**

(52) **U.S. Cl.**
USPC **D15/140**; D8/349; D8/396

(58) **Field of Classification Search**
USPC D8/8, 14, 36, 61, 89, 130, 142, 337, 349, D8/352, 373, 499; D13/8; D15/4, 5, 9, D15/29, 77, 102, 130, 140, 199, 230, D15/230.12, 230.14, 230.16; D18/10, D18/34.2, 34.8, 40, 46, 58; D24/219, D24/232; D32/1, 3, 5, 7, 13, 14, 19, 21, D32/23, 25, 27, 29, 32, 33, 35
CPC B23Q 5/043; B24D 5/16; H01L 27/1021
See application file for complete search history.

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Primary Examiner — Melanie H Tung
Assistant Examiner — Fritzgerald L Butac
(74) *Attorney, Agent, or Firm* — Fitch, Even, Tabin & Flannery

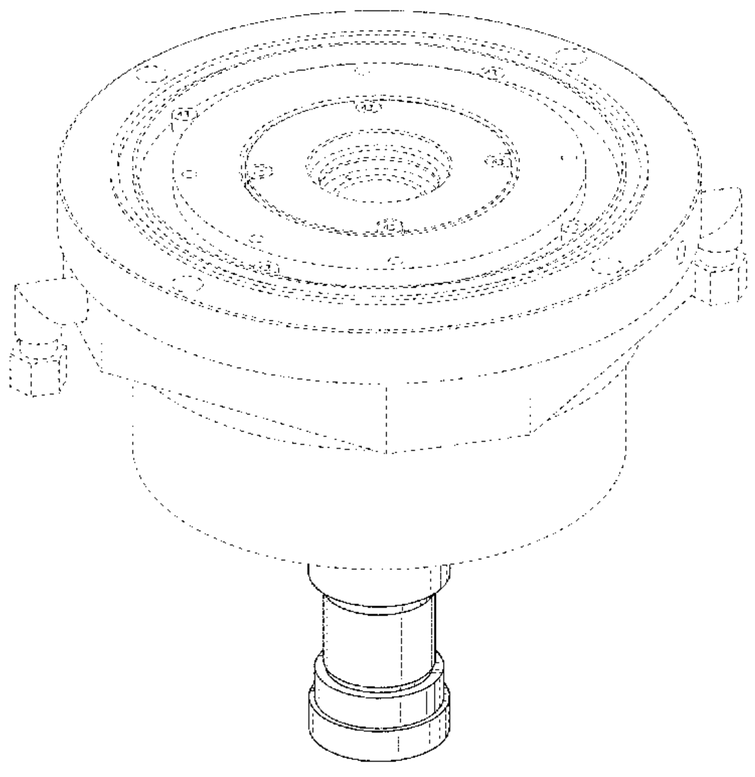
(57) **CLAIM**

We claim the ornamental design for a rotary tool for boat of semiconductor manufacturing apparatus, as shown (and described).

DESCRIPTION

FIG. **1** is a perspective view of a rotary tool for boat of semiconductor manufacturing apparatus showing my new design;
FIG. **2** is a front elevational view thereof;
FIG. **3** is a rear elevational view thereof;
FIG. **4** is a left side elevational view thereof;
FIG. **5** is a right side elevational view thereof;
FIG. **6** is a top plan view thereof;
FIG. **7** is a bottom plan view thereof; and,
FIG. **8** is a cross-sectional view taken along line **8-8** in FIG. **6** thereof.
The broken lines show portions of a rotary tool for boat of semiconductor manufacturing apparatus which form no part of the claimed design.
The "dash-dot" broken lines define the bounds of the claim and form no part thereof.

1 Claim, 8 Drawing Sheets



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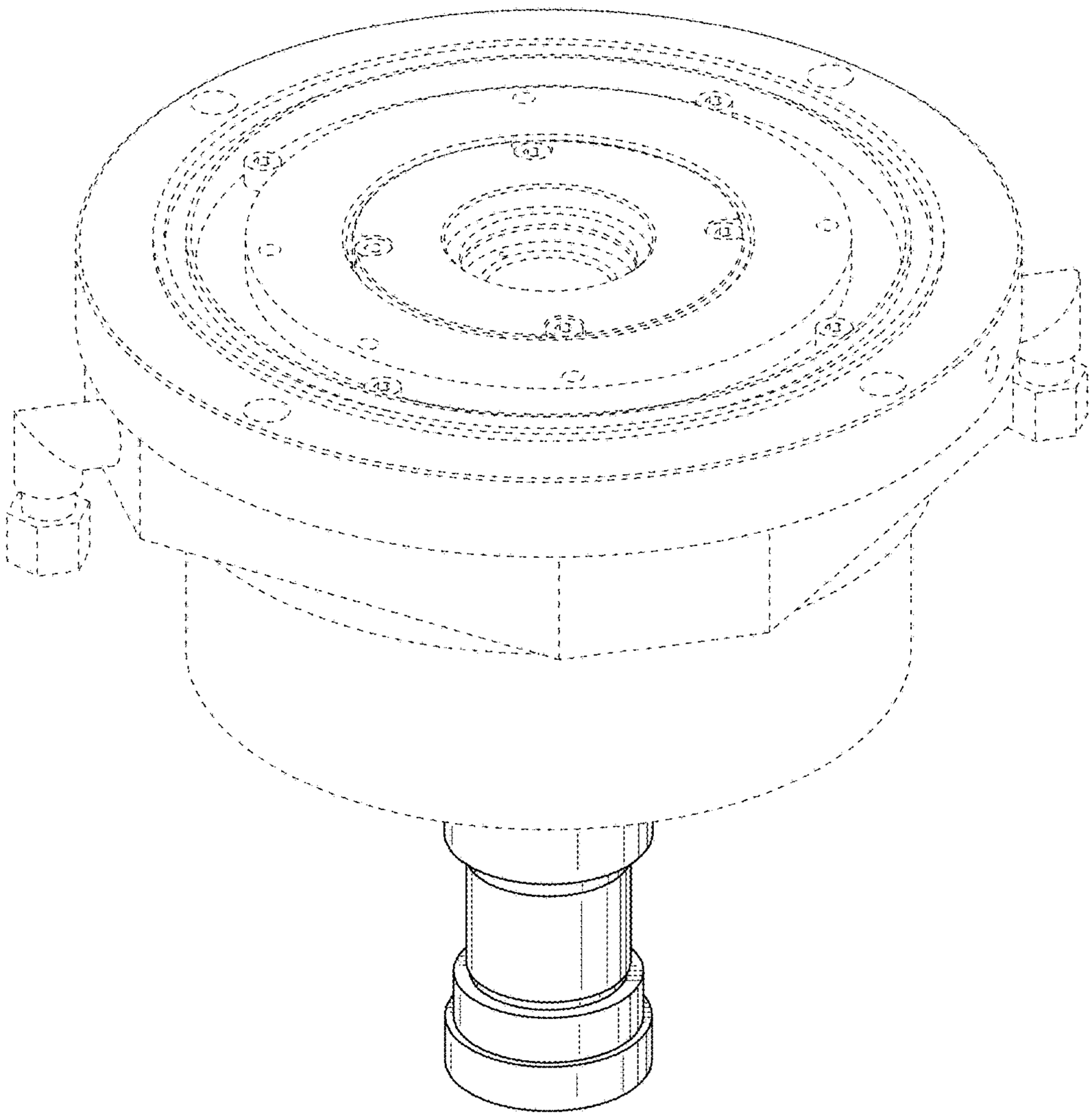

FIG. 1

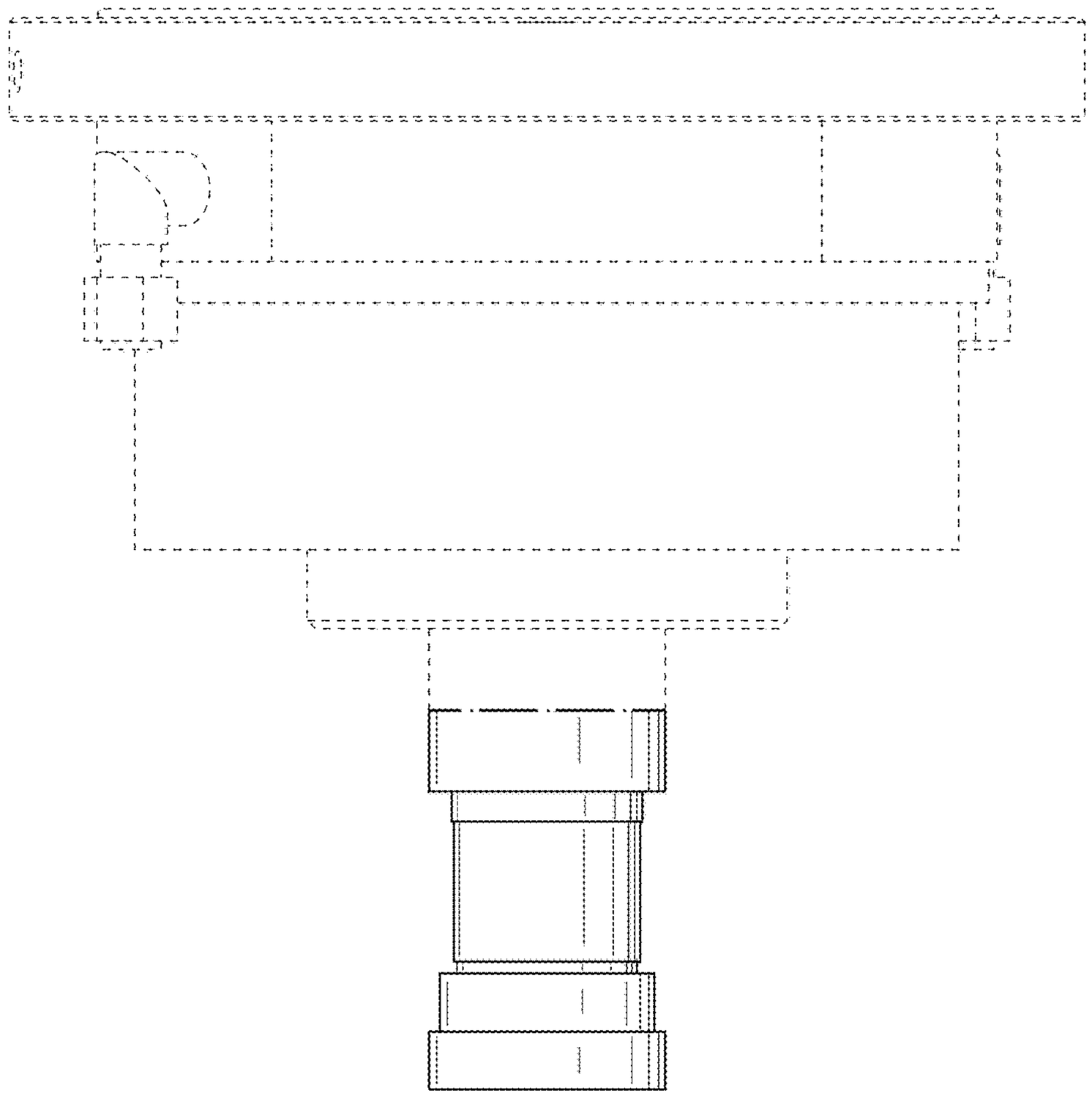

FIG. 2

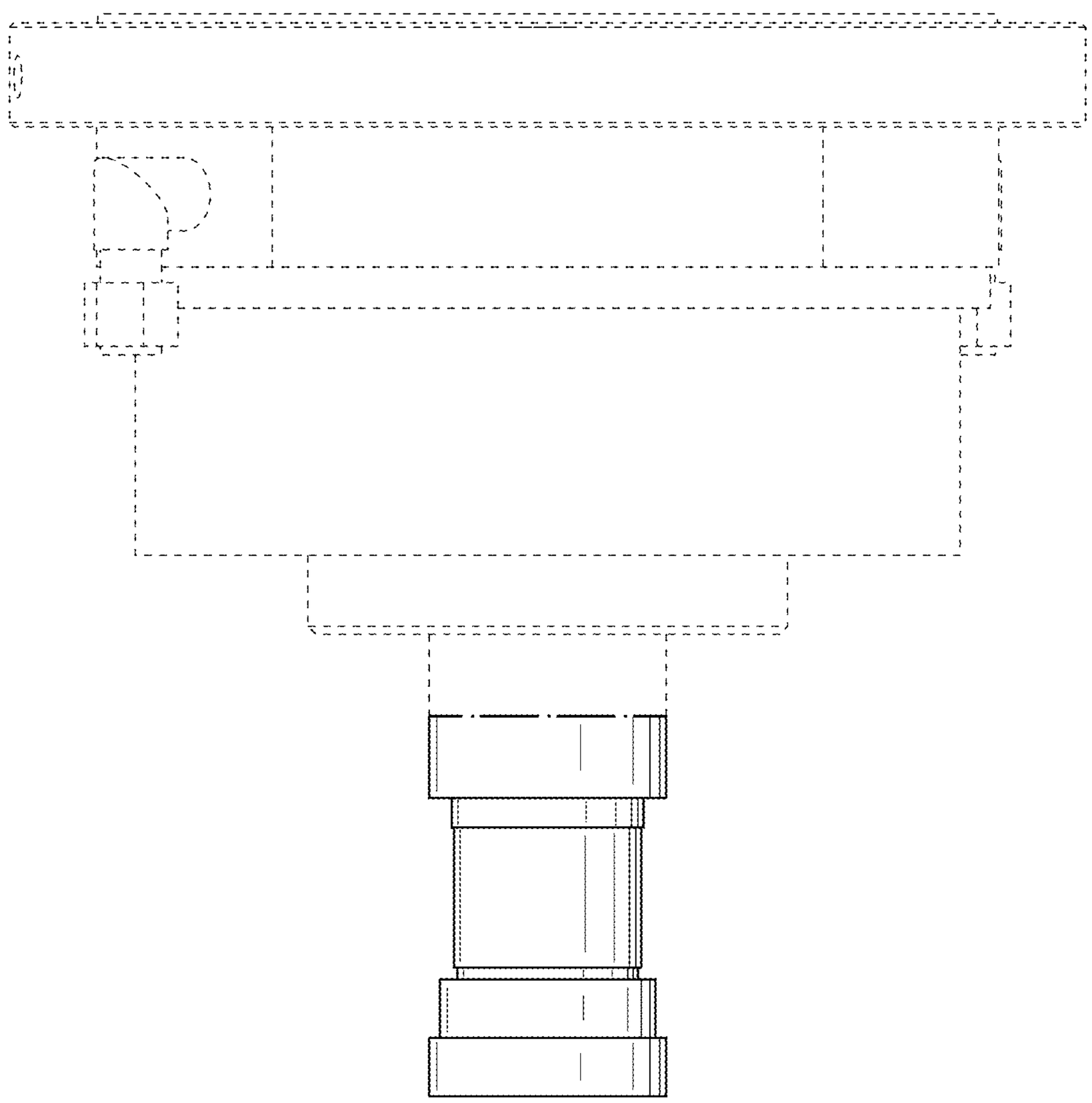

FIG. 3

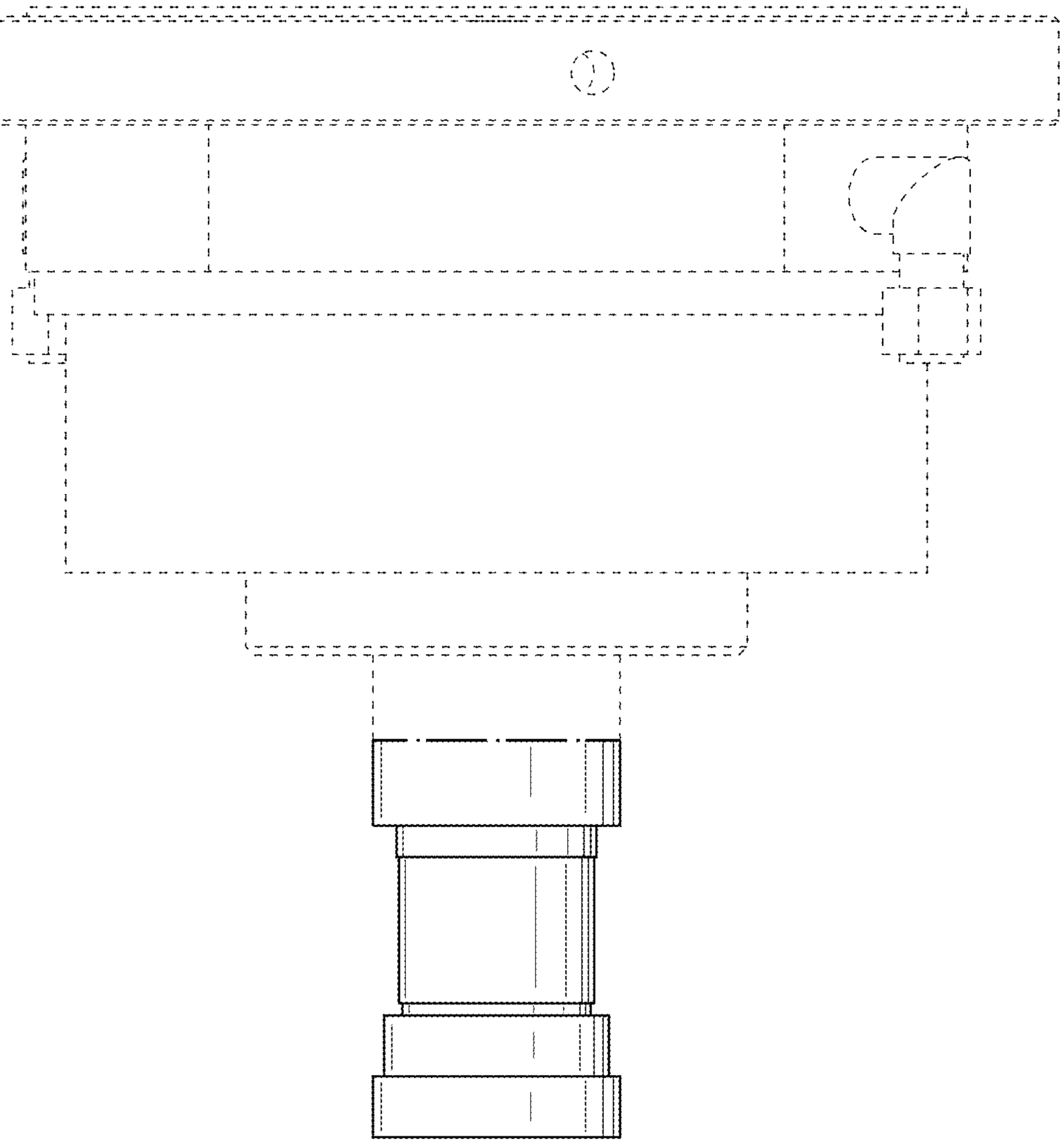

FIG. 4

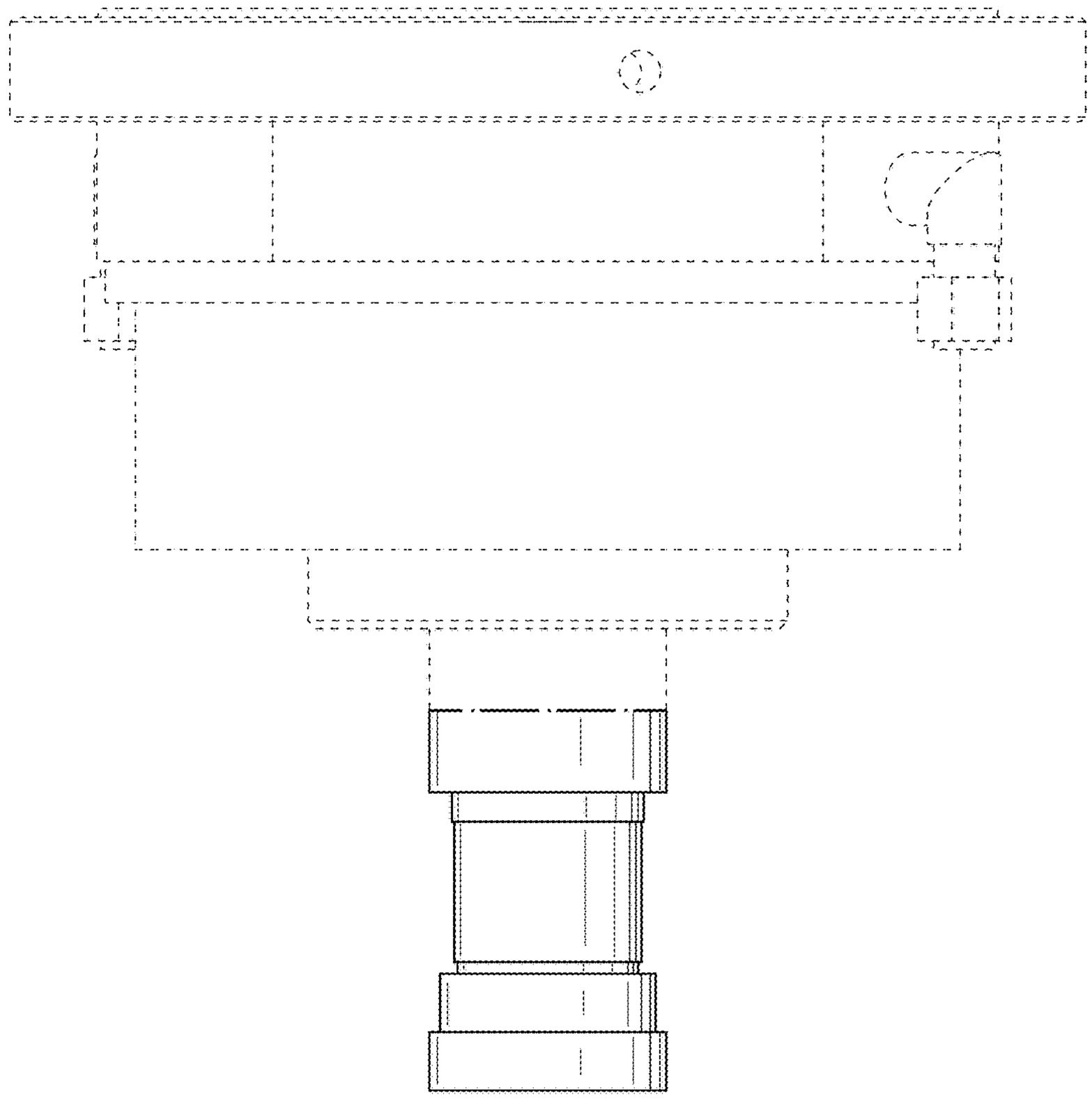

FIG. 5

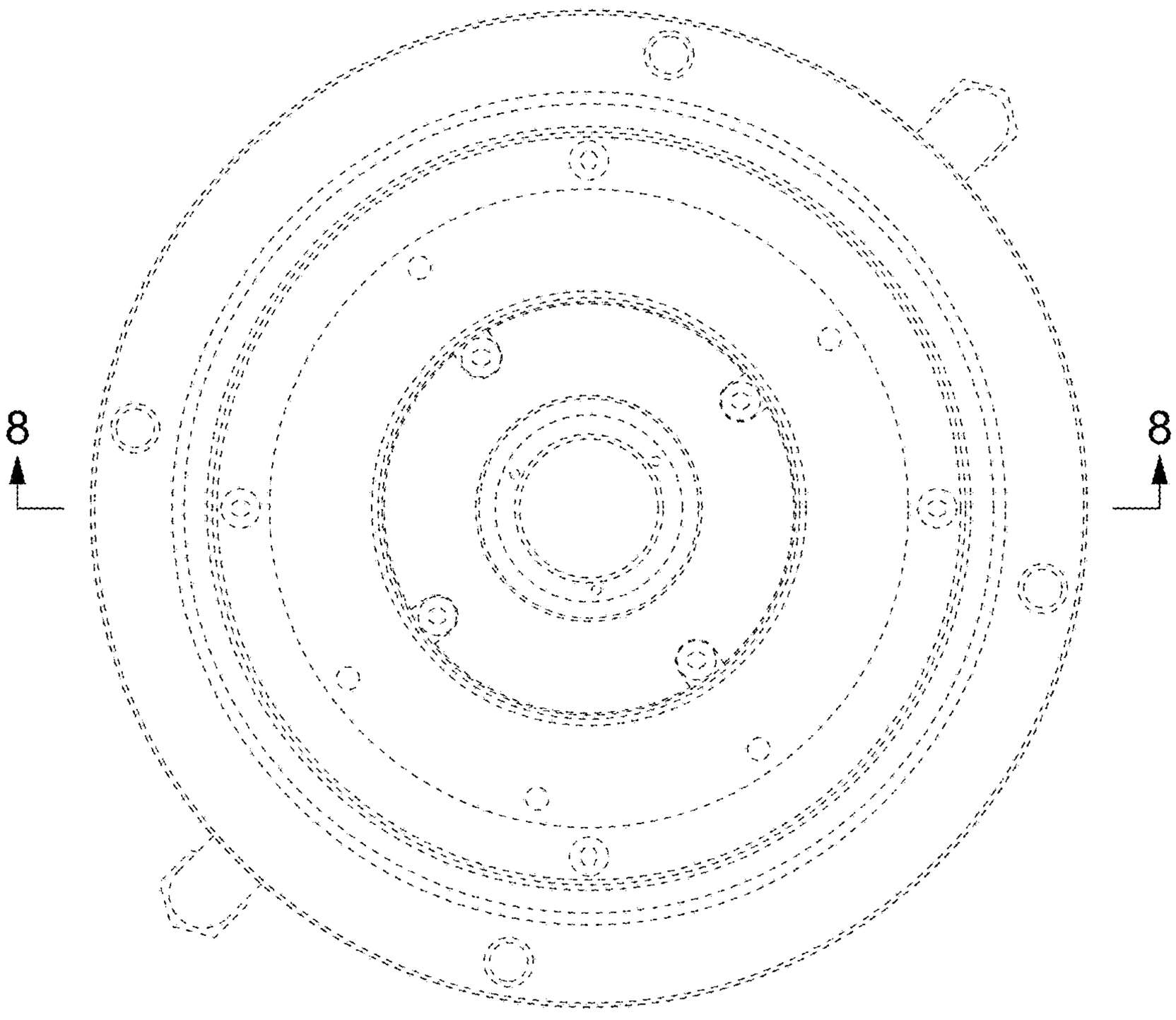

FIG. 6

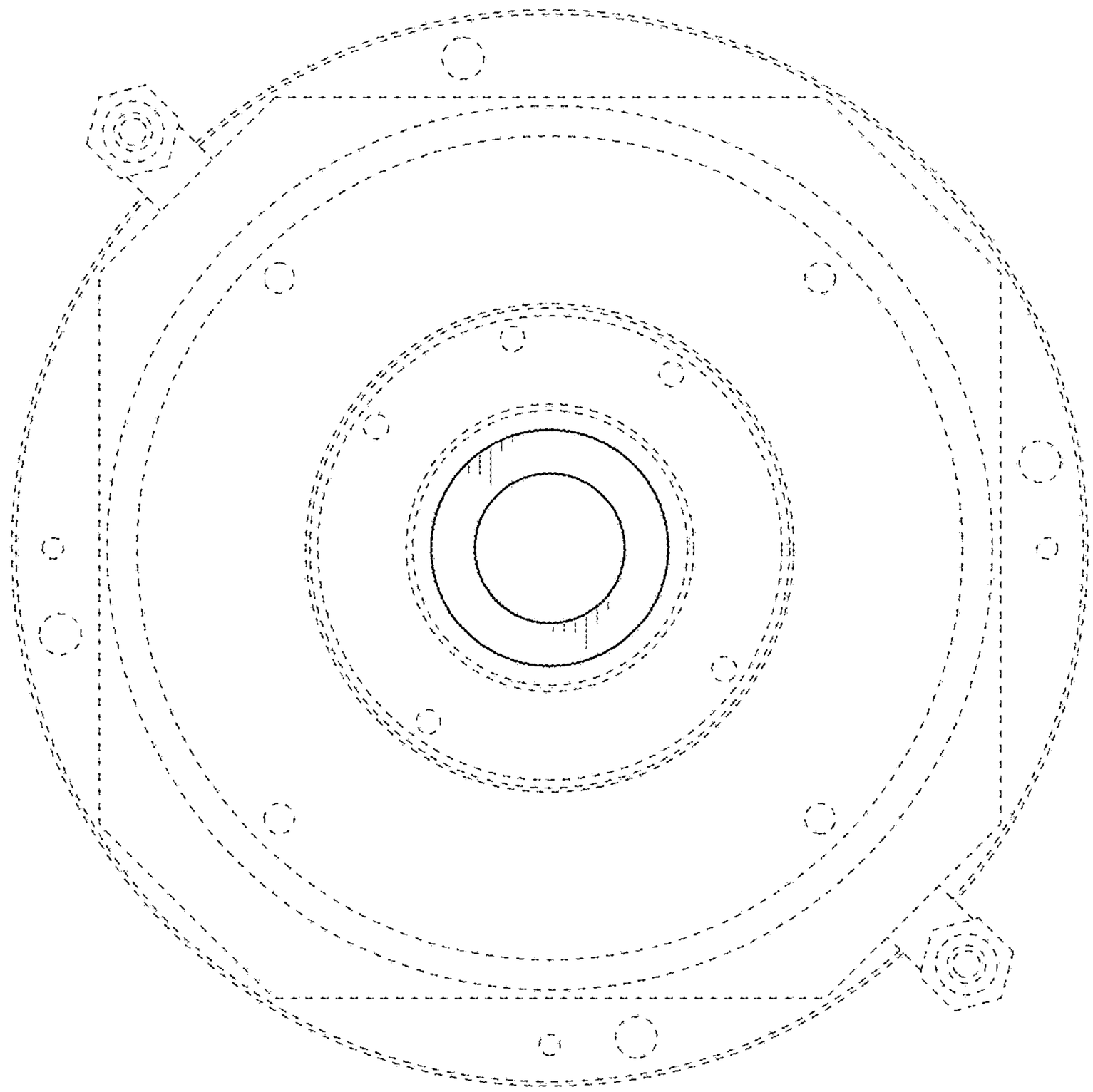

FIG. 7

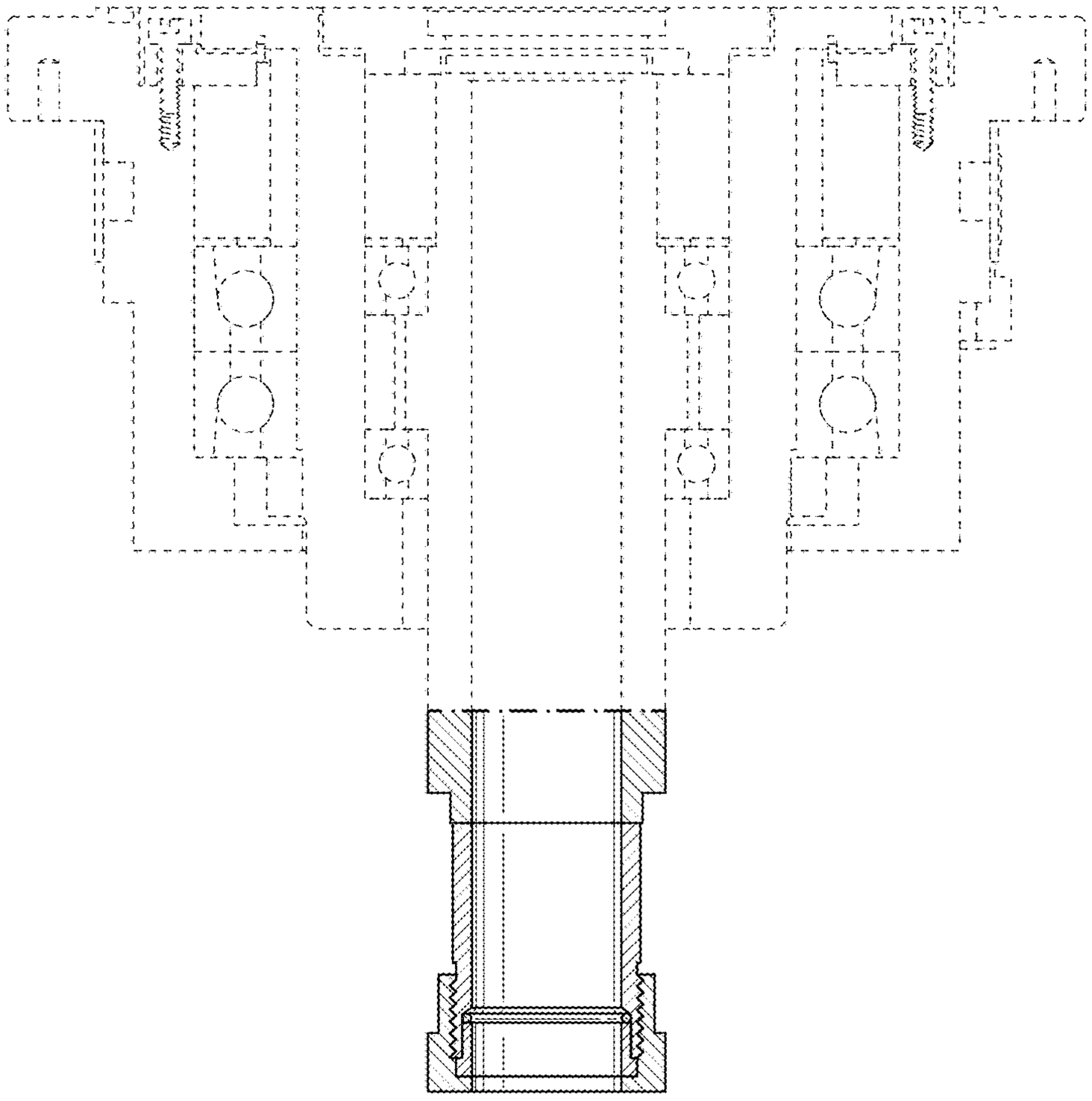

FIG. 8